

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I _F	20	mA
	Forward current derating (Ta ≥ 70°C)	ΔI _F / ΔTa	-0.36	mA / °C
	Peak transient forward current (Note 1)	I _{FPT}	1	A
	Reverse voltage	V _R	5	V
	Diode power dissipation	P _D	40	mW
	Diode power dissipation derating (Ta ≥ 70°C)	ΔP _D / °C	-0.72	mW / °C
	Junction temperature	T _j	125	°C
Detector	"H" peak output current (P _W ≤ 2.5 μs, f ≤ 15 kHz) (Note 2)	I _{OPH}	-1.5	A
	"L" peak output current (P _W ≤ 2.5 μs, f ≤ 15 kHz) (Note 2)	I _{OPL}	+1.5	A
	Output voltage	V _O	35	V
			24	
	Supply voltage	V _{CC}	35	V
			24	
	Output voltage derating (Ta ≥ 70°C)	ΔV _O / ΔTa	-0.73	V / °C
	Supply voltage derating (Ta ≥ 70°C)	ΔV _{CC} / ΔTa	-0.73	V / °C
	Power dissipation	P _C	800	mW
	Power dissipation derating (Ta ≥ 70°C)	ΔP _C / °C	-14.5	mW / °C
	Junction temperature	T _j	125	°C
	Operating frequency (Note 3)	f	25	kHz
Operating temperature range		T _{opr}	-20 to 85	°C
Storage temperature range		T _{stg}	-55 to 125	°C
Lead soldering temperature (10 s)		T _{sol}	260	°C
Isolation voltage (AC, 60 s., R.H. ≤ 60 %) (Note 4)		BV _S	2500	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Pulse width P_W ≤ 1 μs, 300 pps

Note 2: Exponential waveform

Note 3: Exponential waveform, I_{OPH} ≤ -1.0 A (≤ 2.5 μs), I_{OPL} ≤ +1.0 A (≤ 2.5 μs)

Note 4: Device considered a two terminal device: Pins 1, 2, 3 and 4 shorted together, and pins 5, 6, 7 and 8 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Input current, on	I _{F(ON)}	7	8	10	mA
Input voltage, off	V _{F(OFF)}	0	—	0.8	V
Supply voltage	V _{CC}	15	—	30	V
Peak output current	I _{OPH} /I _{OPL}	—	—	±0.5	A
Operating temperature	T _{opr}	-20	25	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Note: A ceramic capacitor(0.1 μF) should be connected from pin 8 to pin 5 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

Note: Input signal rise time(fall time) < 0.5 μs.

Electrical Characteristics (Ta = -20 to 70°C, unless otherwise specified)

Characteristic		Symbol	Test Cir- cuit	Test Condition		Min	Typ.*	Max	Unit
Input forward voltage		V _F	—	I _F = 10 mA, T _a = 25 °C		—	1.6	1.8	V
Temperature coefficient of forward voltage		ΔV _F / ΔT _a	—	I _F = 10 mA		—	-2.0	—	mV / °C
Input reverse current		I _R	—	V _R = 5 V, T _a = 25 °C		—	—	10	μA
Input capacitance		C _T	—	V = 0 V, f = 1 MHz , T _a = 25 °C		—	45	250	pF
Output current	“H” level	I _{OPH}	1	V _{CC} = 30 V (Note 1)	I _F = 10 mA V ₈₋₆ = 4 V	-0.5	-1.5	—	A
	“L” level	I _{OPL}	2		I _F = 0 mA V ₆₋₅ = 2.5 V	0.5	2	—	
Output voltage	“H” level	V _{OH}	3	V _{CC1} = +15 V, V _{EE1} = -15 V R _L = 200 Ω, I _F = 5 mA	11	12.8	—	V	
	“L” level	V _{OL}	4	V _{CC1} = +15 V, V _{EE1} = -15 V R _L = 200 Ω, V _F = 0.8 V	—	-14.2	-12.5		
Supply current	“H” level	I _{CCH}	—	V _{CC} = 30 V, I _F = 10mA T _a = 25 °C	—	7	—	mA	
				V _{CC} = 30 V, I _F = 10 mA	—	—	11		
	“L” level	I _{CCL}	—	V _{CC} = 30 V, I _F = 0 mA T _a = 25 °C	—	7.5	—		
				V _{CC} = 30 V, I _F = 0 mA	—	—	11		
Threshold input current	“Output L→H”	I _{FLH}	—	V _{CC1} = +15 V, V _{EE1} = -15 V R _L = 200 Ω, V _O > 0 V	—	1.2	5	mA	
Threshold input voltage	“Output H→L”	V _{FHL}	—	V _{CC1} = +15 V, V _{EE1} = -15 V R _L = 200 Ω, V _O < 0 V	0.8	—	—	V	
Supply voltage		V _{CC}	—	—		10	—	35	V
Capacitance (input-output)		C _S	—	V _S = 0 V, f = 1 MHz T _a = 25 °C		—	1.0	2.0	pF
Resistance(input-output)		R _S	—	V _S = 500 V , T _a = 25 °C R.H. ≤ 60 %		1×10 ¹²	10 ¹⁴	—	Ω

* All typical values are at Ta = 25°C

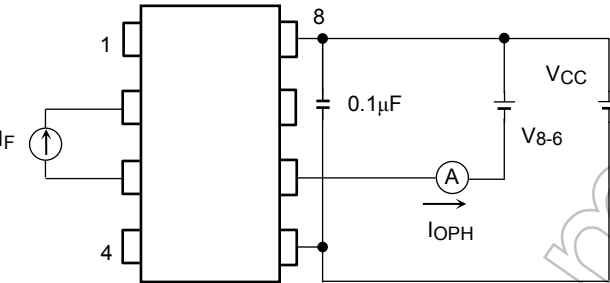
Note 1: Duration of I_O time ≤ 50μs

Switching Characteristics (Ta = -20 to 70°C, unless otherwise specified)

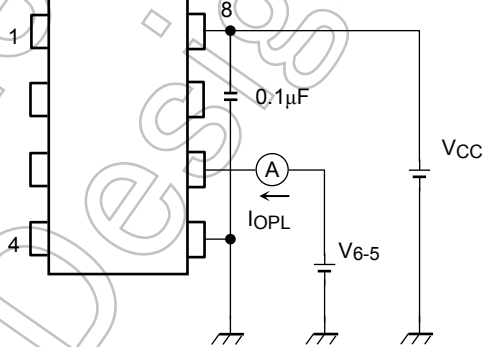
Characteristic		Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Propagation delay time	L→H	t _{pLH}	5	I _F = 8 mA V _{CC1} = +15 V, V _{EE1} = -15 V R _L = 200 Ω	—	0.15	0.5	μs
	H→L	t _{pHL}			—	0.15	0.5	
Common mode transient immunity at high level output		CM _H	6	V _{CM} = 600 V, I _F = 8 mA V _{CC} = 30 V, Ta = 25 °C	-5000	—	—	V / μs
Common mode transient immunity at low level output		CM _L		V _{CM} = 600 V, I _F = 0 mA V _{CC} = 30 V, Ta = 25 °C	5000	—	—	V / μs

Note: All typical values are at Ta = 25°C

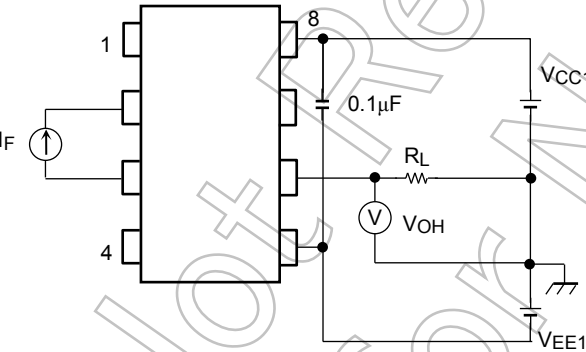
Test Circuit 1 : I_{OPH}



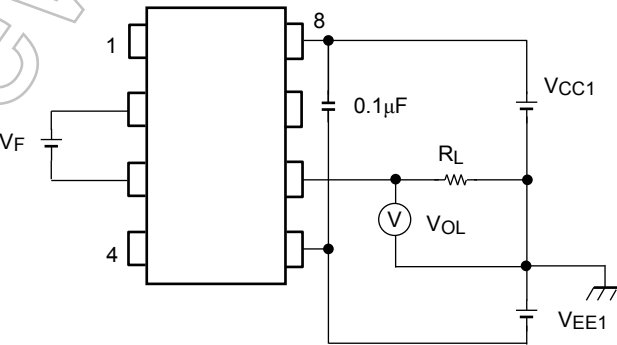
Test Circuit 2 : I_{OPL}

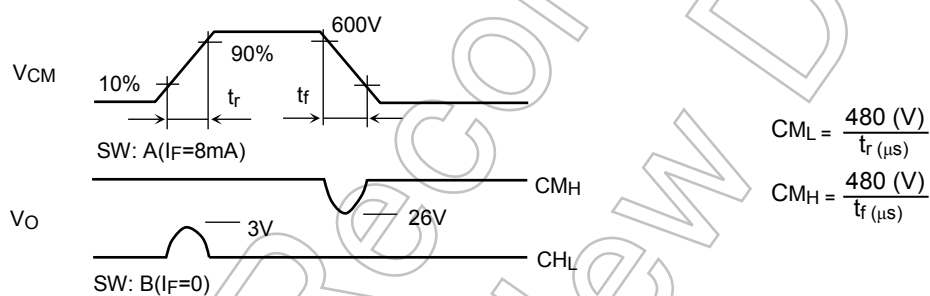
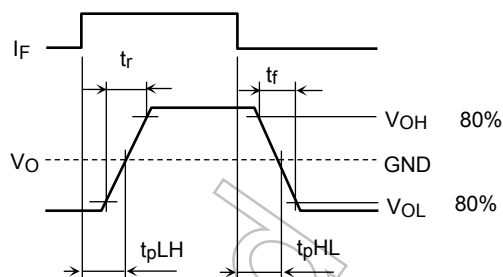


Test Circuit 3 : V_{OH}

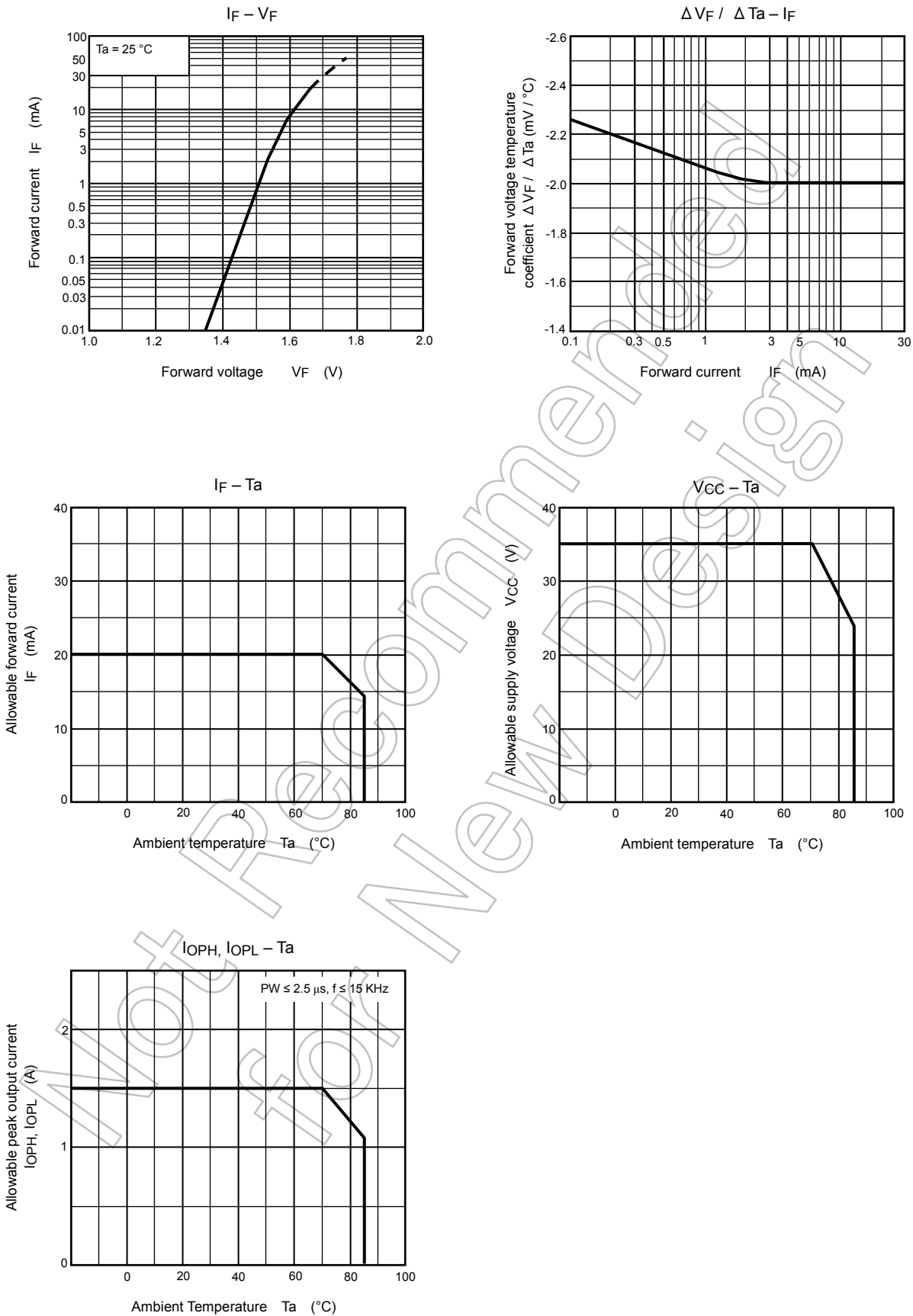


Test Circuit 4 : V_{OL}





Not for



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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